## PATENT ASSIGNMENT

# Electronic Version v08 Stylesheet Version v02

SUBMISSION TYPE:		NEW ASSIGNMENT APPLICATION NUMBER 11/307127			
NATURE OF CONVEYANCE:		ASSIGNMENT OF ASSIGNOR'S INTEREST			
CONVEYING PARTY D	ΑΤΑ				
Name		Execution Date	]		
Ke-Hung Chen		06-01-24			
		06-01-24			
Mou-Shiung Lin 200		06-01-24			
	TA				
Name	Street Address	Internal Address	City	State/Country	Postal Code
MEGIC Corporation	21, R&D 1ST. Rd., Science-Based Industrial Park Hsinchu		Hsin-Chu City	TAIWAN	
	6673 <i>sent via US Mail when tl</i> nber has been provided, he USPTO.	<i>he fax attempt is unsucce</i> the Office of Public Reco		correspondence data	from the
NAME OF PERSON SIGNING:		WINSTON HSU			
DATE SIGNED:		2006-01-23			
Total Attachments: 2 source=MEGP0037-0-A source=MEGP0037-0-A					

## ASSIGNMENT OF INVENTION

In consideration of the payment by ASSIGNEE to ASSIGNOR of the sum of One Dollar (\$1.00), the receipt of which is hereby acknowledged, and for other good and valuable consideration.

#### ASSIGNOR(S) (Inventors):

Name:	Ke-Hung Chen	Nationality: R.O.C.			
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Name:	Shih-Hsiung Lin	Nationality: R.O.C.			
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Name:	Mou-Shiung Lin	Nationality: U.S.A			
Address:	28 Ginsan 10th Street, Hsin-Chu, Taiwan, R.O.C.				
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Hereby sells, assigns and transfers to

### ASSIGNEE(S):

Name: MEGIC Corporation

Address: 21, R&D 1ST. Rd., Science-Based Industrial Park Hsinchu, Hsin-Chu City 300, Taiwan, R.O.C.

and the successors and assignees of the ASSIGNEE the entire right, title, and interest in and to any and all improvements which are disclosed in the invention entitled:

#### "MULTI-CHIP STRUCTURE AND METHOD OF ASSEMBLING CHIPS"

Which is found in :

- (a) + U.S. patent application executed on even date
- (b) \_\_\_\_\_ U.S. patent application executed on \_\_\_\_\_
- (c) \_\_\_\_\_ U.S. application serial no.\_\_\_\_\_

(d) patent no. \_\_\_\_\_ issued \_\_\_\_\_

NPO#MEG-P0037-USA:0 CUST#MEG 04-012 Assignment, Page 1 of 2

F#NPO-P0002E-US1 PATENT REEL: 017056 FRAME: 0892

PATENT

and, in and to, all Letters Patent to be obtained for said invention by the above application or any continuations, continuation-in-part, divisions, renewals, substitutes, or extensions thereof, and as to Letters Patent any roissue or re-examination thereof

ASSIGNOR hereby covenants that no assignment, sale, agreement or encumbrance, has been or will be made or entered into which would conflict with this assignment,

ASSIGNOR further covenants that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said invention and said Letters Patent and legal equivalents as may be known and accessible to ASSIGNOR and will testify as to the same in any interference, litigation or proceeding related thereto and will promptly execute and deliver to ASSIGNEE or its legal representatives my and all papers, instruments or affidavits required to apply for, obtain, maintain, issue and enforce said application, said invention and said Letters Patent and said equivalents thereof which may be necessary or desirable to carry out the proposes thereof.

IN WITNESS WHEREOF, We have hereunto sot hand and scal this 2 4 2006 bate of signing). (###A##A###1##.)

(Type name of inventor)
Ko-Hung Chen

Shih-Hsinng Lin

Mou-Shiung Lin

Signature of INVENTOR Ke

NPO#MIX1-20037-USA:0 (UST#ME0 04-012 Assignment, Page 2 of 2

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**RECORDED: 01/24/2006**